

CrystalClear™ AC '97 Six Channel Secondary ACR Audio Reference Design**Features**

- Six Channel Analog Audio Output
 - Two channels on the Motherboard
 - Four channels on the CRD4201-2S
- CS4201 audio codec and CS4334 DAC
- 20-bit D to A conversion (DAC)
- 18-bit A to D conversion (ADC)
- S/PDIF (IEC-958) optical digital output
- Complete suite of Analog I/O connections:
 - Line, Mic, CD, Video, and Aux Inputs
 - Line Rear, and Line Center/Sub-Woofers Outputs
- 2-layer low cost PC board
- Meets Intel® AC '97 version 2.1 specification
- Exceeds Microsoft's® PC-2001 audio performance requirements.

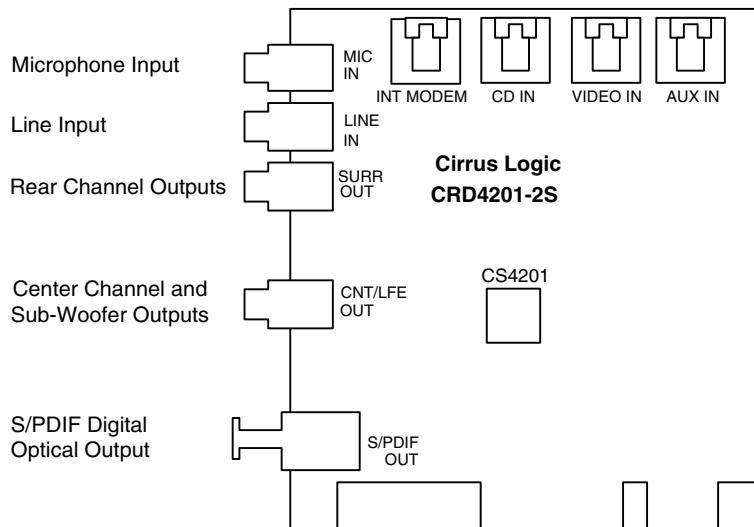
Description

The CRD4201-2S Advanced Communications Riser (ACR) reference design features four channel analog audio outputs and an optical S/PDIF digital output. This board is designed to provide the rear left, rear right, center and sub-woofer channels in a six channel ACR audio sub-system. The front left and front right channels are provided by the primary audio codec on the motherboard. This board uses the CS4201 configured as a secondary audio codec which has several advanced features. These include a serial digital audio output and up to 30 dB of microphone boost.

The CRD4201-2S reference design is available by ordering the CMK4201-2 manufacturing kit. This kit includes the CRD4201-2, the CRD4201-2S, a full set of schematic design files (OrCAD® format), PCB job files (PADS® ASCII), PCB artwork files, and bill of materials. This reference design offers significant cost savings over competing solutions and can be easily modified to meet your specific design goals.

ORDERING INFO

CMK4201-2 (Manufacturing Kit)

**Preliminary Product Information**

This document contains information for a new product.
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1. GENERAL INFORMATION

The CRD4201-2S reference design is an ACR card that features four channel CD quality analog audio outputs. Combined with a CS4201 audio codec on the motherboard, the CRD4201-2S forms the rear left, rear right, center, and sub-woofer outputs of a six channel PC audio sub-system. The card includes a CS4201 AC '97 audio codec and a CS4334 24-bit serial stereo DAC. This combination gives the CRD4201-2S a rich feature set and industry leading audio performance.

The CS4201 on this card is configured as the secondary AC '97 audio codec. This board must be used in conjunction with a CS4201 audio codec on the motherboard. For applications requiring a complete six channel audio subsystem on a single ACR card, use the CRD4201-2 also included in the CMK4201-2 manufacturing kit.

The CS4201 audio codec has a stereo 20-bit DAC providing 2 channels of audio output, a stereo 18-bit ADC, and a very flexible analog audio mixer. A CS4334 DAC is connected to the CS4201 serial output to provide two additional channels of analog audio. The CS4201 also features three stereo pairs of line level analog inputs, a microphone input, and a stereo pseudo-differential CD input. The input signals can be routed to the ADC for recording or mixed together for recording and direct playback. The CS4201 has internal registers that are used to control its various features such as volume levels, audio muting, and signal routing. The CS4201 maintains high audio quality and exceeds the Microsoft[®] PC-99 and PC-2001 audio performance specification.

The CS4201 audio codec communicates to the audio controller across the ACR interface through the AC-Link. The AC-Link is a 5-wire serial digital interface that transfers digital audio between the two devices and also sends commands from the audio controller to the CS4201's registers. For more in-

formation on the AC-Link, see the Intel[®] AC'97 version 2.1 specification.

2. SCHEMATIC DESCRIPTION

The block diagram in Figure 1 illustrates the interconnections between the schematic pages found at the end of this document. Sections 2.1 through 2.8 describe the circuitry contained in these schematics. Note: this design is based on the CRD4201-1 six channel reference design with some population option changes.

2.1 CS4201 Audio Codec

The CS4201 audio codec is shown in Figure 2. The input signals to the CS4201 originate from the analog inputs in Figure 3, and the analog outputs are shown in Figure 5. AFLT1 and AFLT2 (pins 29, 30) require 1000 pF NPO/COG capacitors connected to analog ground. These capacitors provide a single pole lowpass filter at the inputs of the ADC. No other input filtering is required.

FLT3D, FLTI, and FLTO (pins 32, 33, and 34) form the internal analog 3D enhancement filter. The FLT3D pin requires a 0.01 μ F capacitor to analog ground. The FLTO and FLTI pins require a NPO/COG 1000 pF series capacitor.

The AC-Link may require series termination resistors to prevent reflections. These are normally placed as close as possible to the transmitting end of a particular AC-Link signal. The SDATA_IN (pin 8) output of the CS4201 has a 47 Ω series termination resistor.

The CS4201 is powered by separate analog and digital power supplies, each with their own respective grounds. The AGND symbols refer to analog ground, and DGND symbols refer to digital ground. The analog and digital grounds must be tied together. For best results, connect them together at a single point with a 0.050 inch trace underneath the CS4201. Each power pin needs separate decoupling capacitors. The CS4201 audio codec uses a 0.1 μ F ceramic capacitor for each of the

3.3 V digital and 5 V analog supply pins. These decoupling capacitors are placed as close as possible to their respective pins.

2.2 Analog Inputs

The LINE_IN, VIDEO_IN, and AUX_IN stereo input jacks in Figure 3 are connected to a 6 dB voltage divider and AC coupled to the CS4201. The voltage divider allows input signal levels of up to 2 Vrms. The 2.2 μ F AC coupling capacitor values are used to minimize low frequency roll-off.

The microphone circuit is AC coupled by a 1 μ F capacitor to minimize low frequency roll-off. The microphone circuit provides low voltage phantom power for electret microphones. Phantom power is derived from the +5 V analog supply and provides a maximum of 4.2 V under no load and a minimum of 2.0 V under a 0.8 mA load. These parameters are required by PC-99 and PC-2001.

The CS4201 features a pseudo-differential CD input that minimizes common mode noise and interference. Each CD signal acts as one side of the differential input and CD_COM acts as the other side. CD_COM is used as the common return path for both the left and right channels.

2.3 Center and Sub-Woofe Outputs

The outputs in Figure 4 drive the center speaker (CNT) and sub-woofer (LFE) in a six channel audio application. These outputs are driven digitally from the CS4201 through a serial output port and converted to analog audio through a high-performance CS4334 24-bit stereo DAC.

2.4 Rear Channel Outputs

Figure 5 details the Rear Channel Output circuit. These are the Rear L and Rear R Outputs in a six channel audio system. They are driven by the Line Output pins of the CS4201.

The Line Outputs of the CS4201 (pins 35 and 36) are buffered by a Motorola MC34072 dual op-amp. The MC34072 is a high performance low noise op-

amp well suited for audio applications. Line Out is designed to drive high impedance loads of 10 K Ω or higher.

2.5 S/PDIF Optical Output

The S/PDIF (IEC-958) digital output shown in Figure 6 is compatible with digital outputs on consumer devices such as Mini Disk recorders and consumer stereo receivers. The S/PDIF output operates at a fixed sampling frequency of 48 KHz. It uses an industry standard TOSLINK digital optical transmitter, the Toshiba TOTX-173.

2.6 ACR Connector and EEPROM

The ACR connector is shown in Figure 7. ACR is a motherboard interface that supports audio, modem, LAN and DSL subsystems. ACR applications are targeted at OEMs, system manufacturers, and system integrators who wish take advantage of physically separating their audio, modem or LAN circuitry from the PC motherboard. ACR accomplishes this without the additional cost associated with the interface circuitry required for a PCI bus add-in card.

The CRD4201-2S uses a 24LC09 EEPROM to store configuration data for plug-and-play enumeration. The 24LC09 is designed specifically for ACR applications. The base address of the device is internally wired to 0xB0. The EEPROM holds the Subsystem Vendor ID and Subsystem ID. For ACR design specifications, programming utilities, and information on programming the EEPROM see the Advanced Communication Riser Special Interest Group (ACR SIG) homepage at <http://www.acrsig.org/>.

2.7 Component Selection

Great attention was given to the particular components used on the CRD4201-2S board with cost, performance, and package selection as the most important factors. Listed are some of the guidelines used in the selection of components:

- No components smaller than 0805 SMT package.
- Only single package passive components. No resistor packs. This reduces the risk of crosstalk between analog audio signals.
- All components except connectors and jumpers are in surface mount packages.

2.8 EMI Components

Optional capacitors and inductors are included to help the board meet EMI compliance tests, such as FCC Part 15. Choose these component values according to individual requirements.

3. GROUNDING AND LAYOUT

The component layout and signal routing of the CRD4201-2S provides a good model for laying out your own ACR add-in card.

3.1 Partitioned Voltage and Ground Planes

It is critical for good audio performance to separate digital and analog sections to prevent digital noise from affecting the performance of the analog circuits. The analog section of the CRD4201-2S is completely isolated from the digital section with a 100 mil partition. Partitioning is defined as the absence of copper on all signal layers. The analog and digital sections each have their own separate ground planes. All analog components, power traces, and signal traces are routed over the analog ground plane. Digital components, power traces and signal traces are not allowed to crossover into the analog section.

The CS4201 audio codec is placed at the transition point between the analog and digital ground planes. The pins are arranged on the CS4201 so that the analog and digital signals are separated from each other. *The analog and digital ground planes must be tied together for the CS4201 to maintain proper voltage references.* For best results, the two ground planes are tied together with a single 50 mil trace under the CS4201 near its digital ground pins.

A separate chassis ground provides a noise-free reference point for all of the EMI suppression components. The chassis ground plane is connected to the analog ground plane at the external jacks.

3.2 CS4201 Layout Notes

Refer to the *CS4201 Data Sheet* for analog and digital partitioning guidelines and bypass capacitor placement. Pay special attention to the bypass capacitors on REFFLT, AFLT1, AFLT2 and the power supply capacitors.



4. REFERENCES

- 1) Intel®, Audio Codec '97 Component Specification, Revision 2.1, May 22, 1998.
<http://developer.intel.com/ial/scalableplatforms/audio/>
- 2) ACR Special Interest Group, ACR Specification 1.0
<http://www.acrsig.org/>
- 3) Cirrus Logic, CS4201 Audio Codec '97 Data Sheet
<http://www.cirrus.com/products>
- 4) Steve Harris, Clif Sanchez, Personal Computer Audio Quality Measurements, Version 1.0
<http://www.cirrus.com/pubs/meas100.pdf>
- 5) Microsoft, PC Design Guidelines,
<http://www.microsoft.com/hwdev/desguid/>
- 6) M. Montrose, Printed Circuit Board Design Techniques for EMC Compliance (2nd edition), IEEE Press, New York: 2000.

4.1 ADDENDUM

- Schematic drawings
- Layout drawings
- Bill of materials

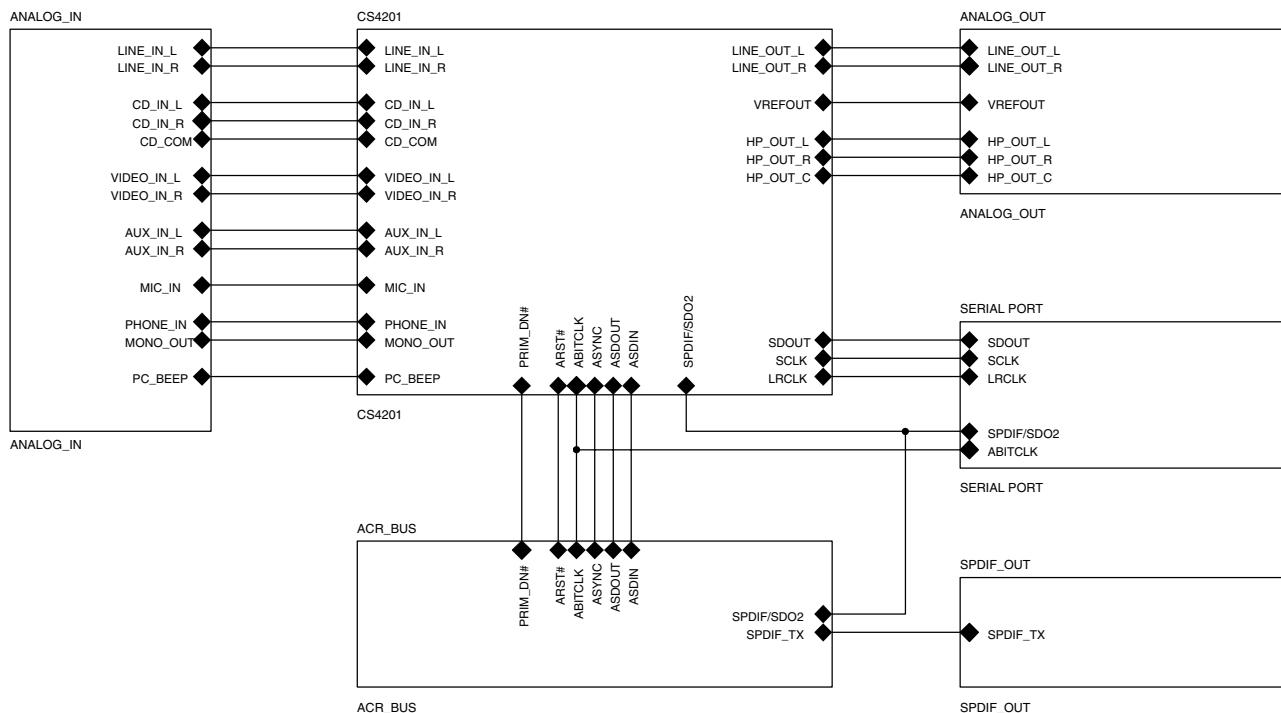


Figure 1. Block Diagram

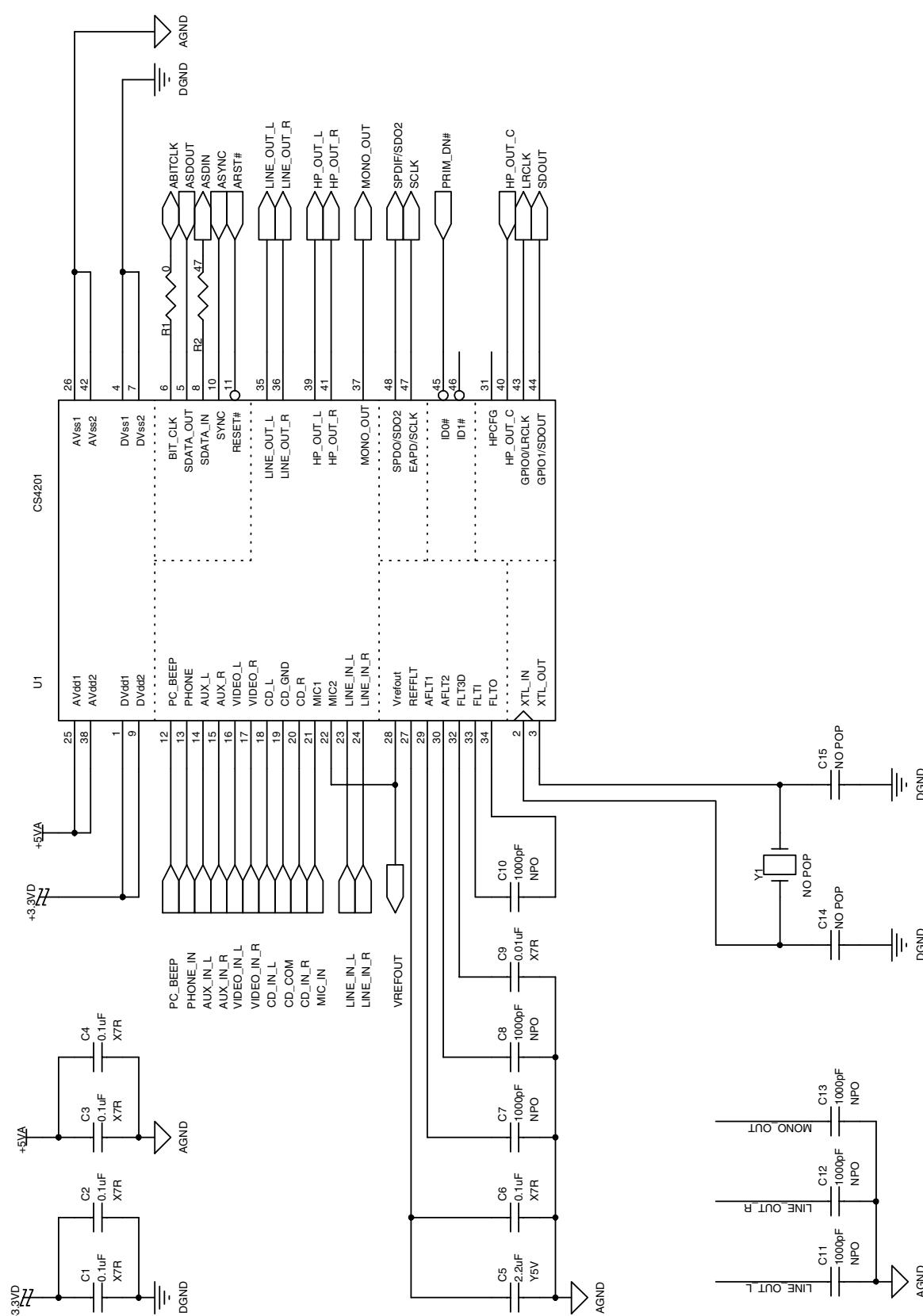


Figure 2. CS4201 Audio Codec

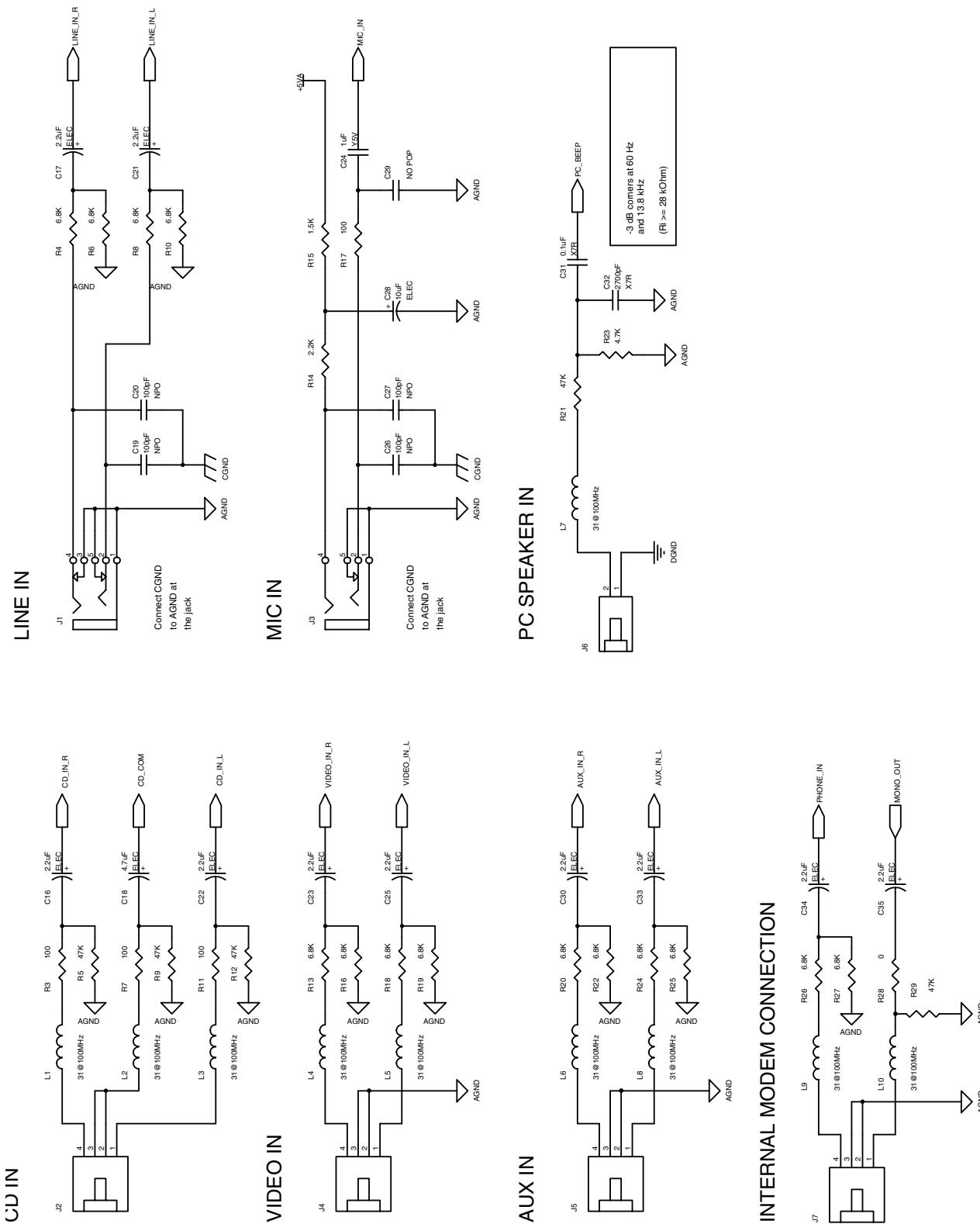


Figure 3. Analog Inputs

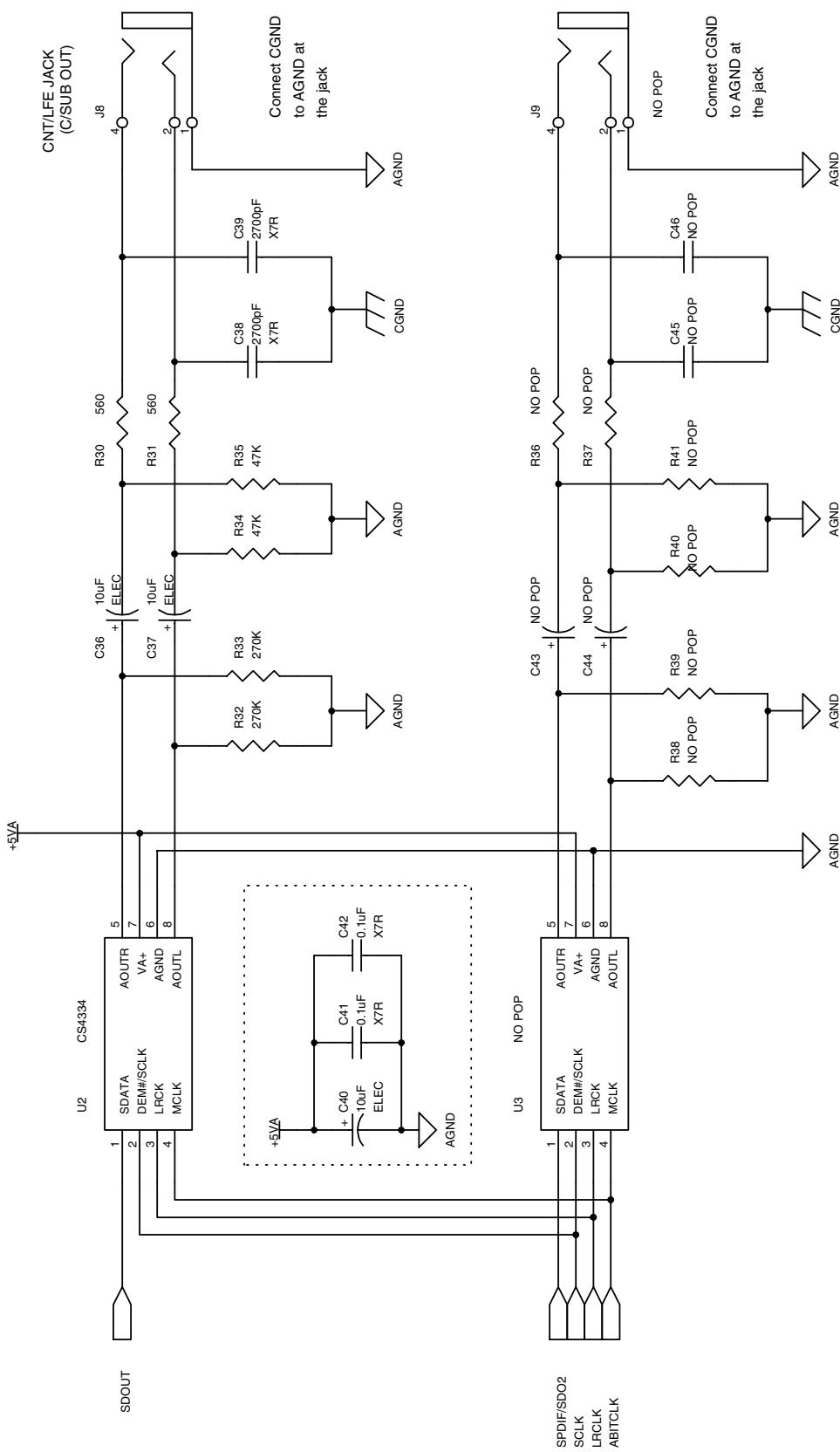
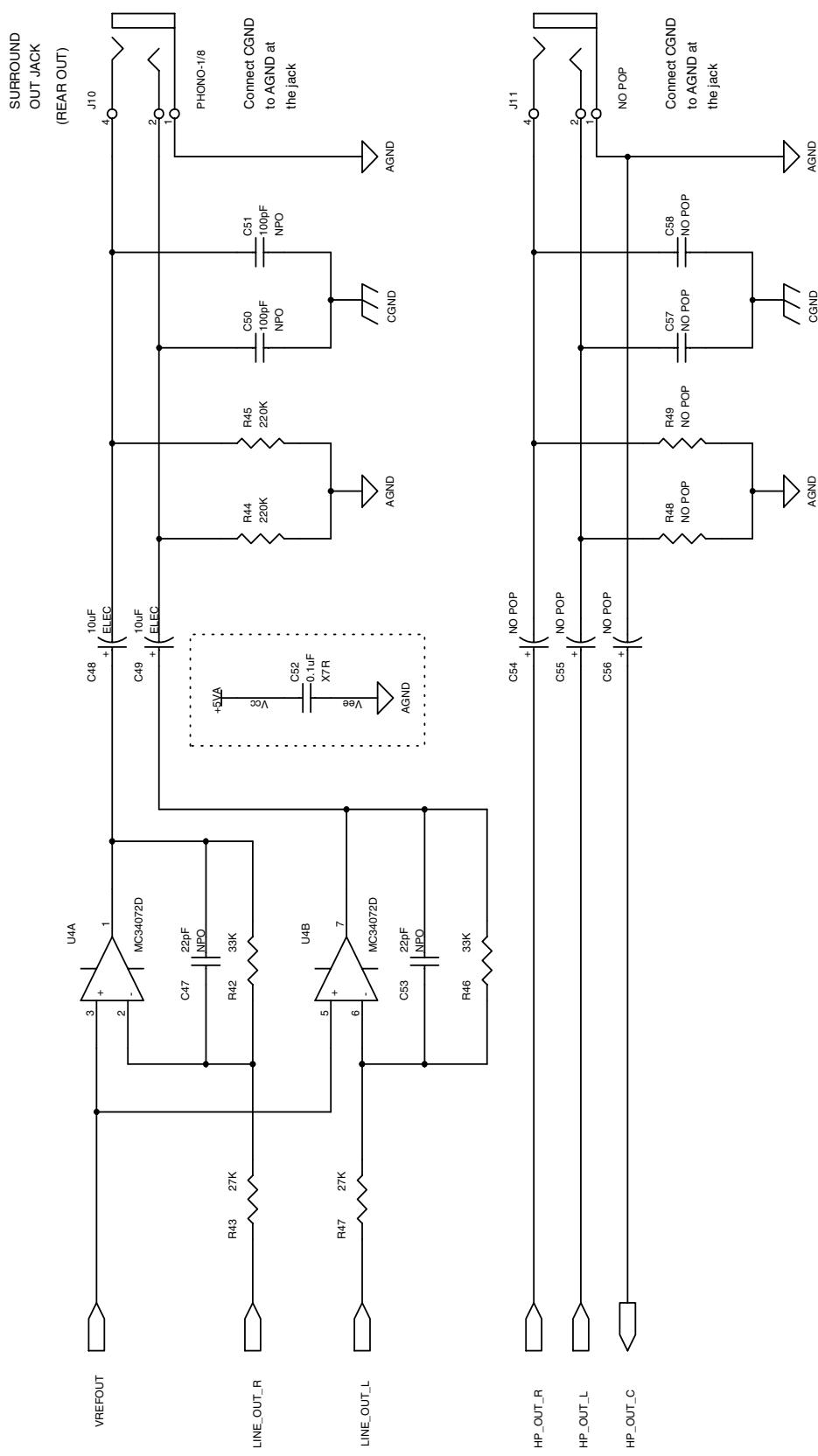


Figure 4. Center Channel and Sub-Woofer Outputs


Figure 5. Rear Channel Outputs

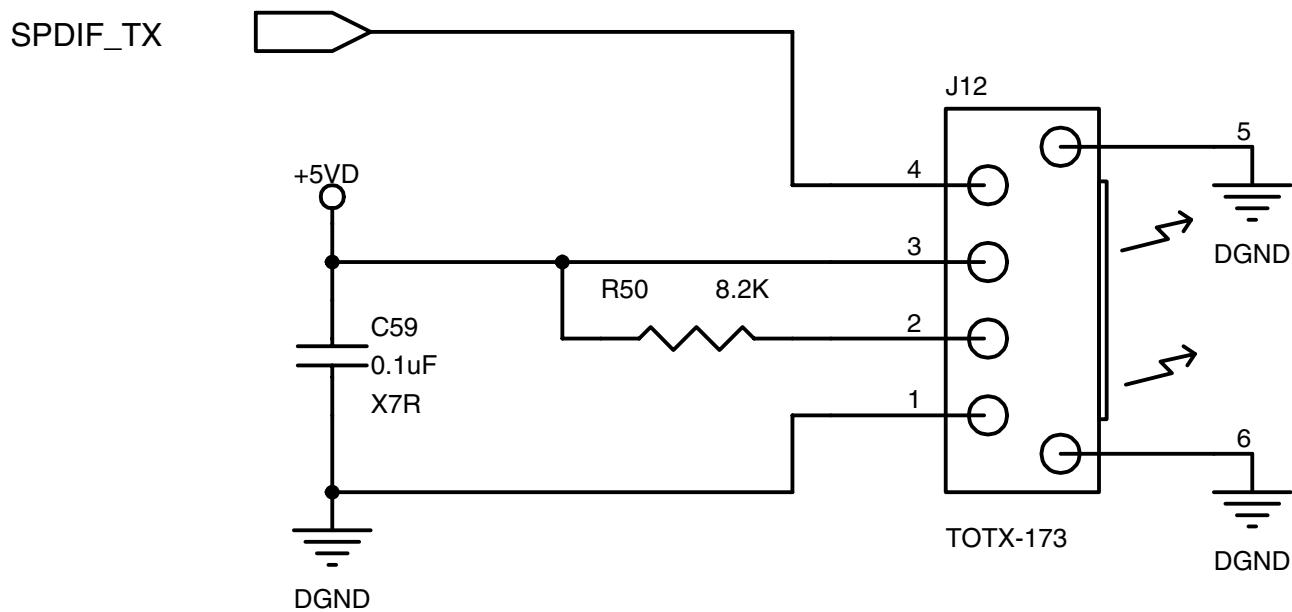
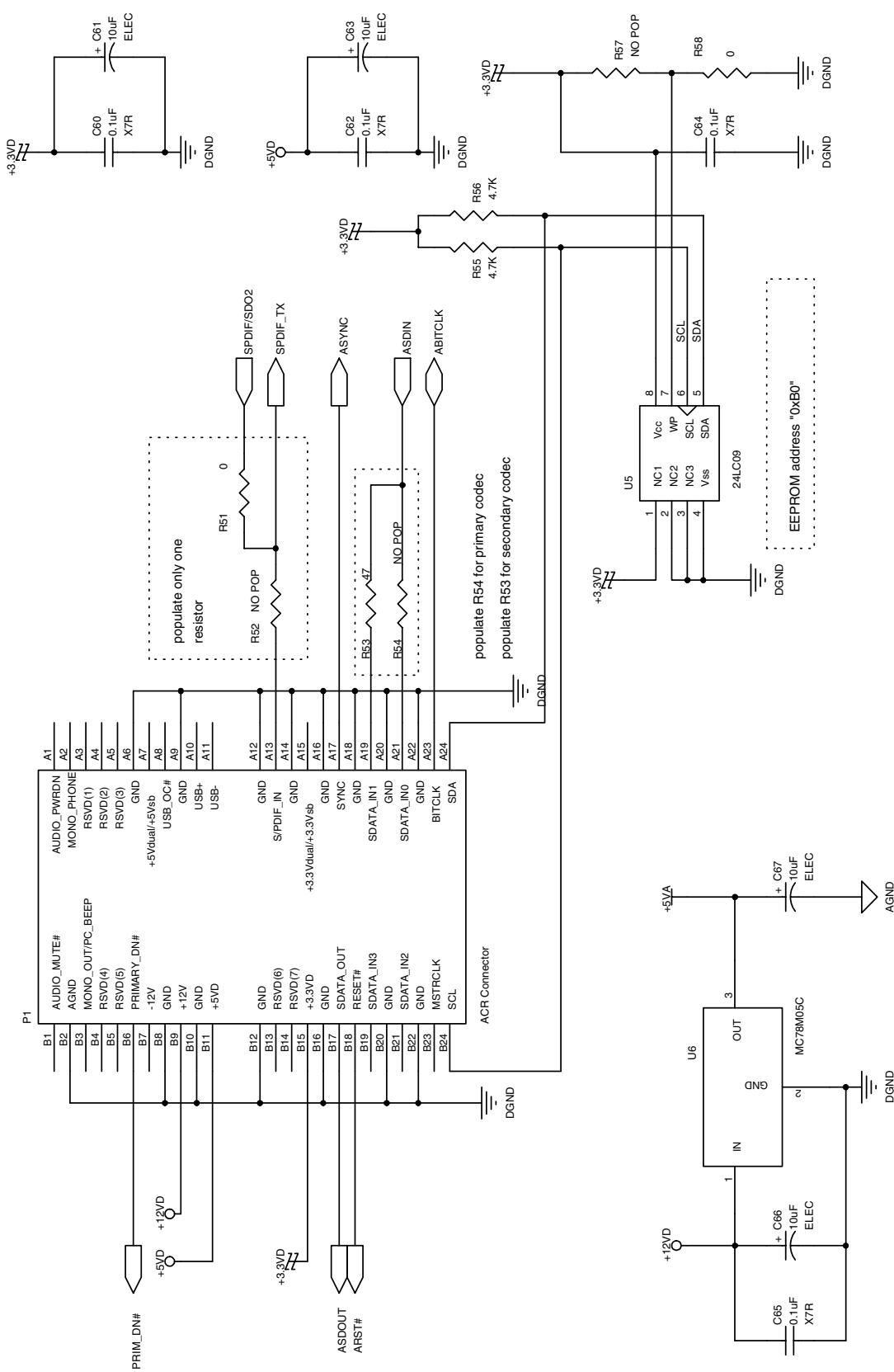


Figure 6. S/PDIF Optical Output



Connect AGND to DGND with a 50 mil trace near the regulator.
Connect CGND to DGND with a 50 mil trace near the finger edge of the board.

Figure 7. ACR Connector

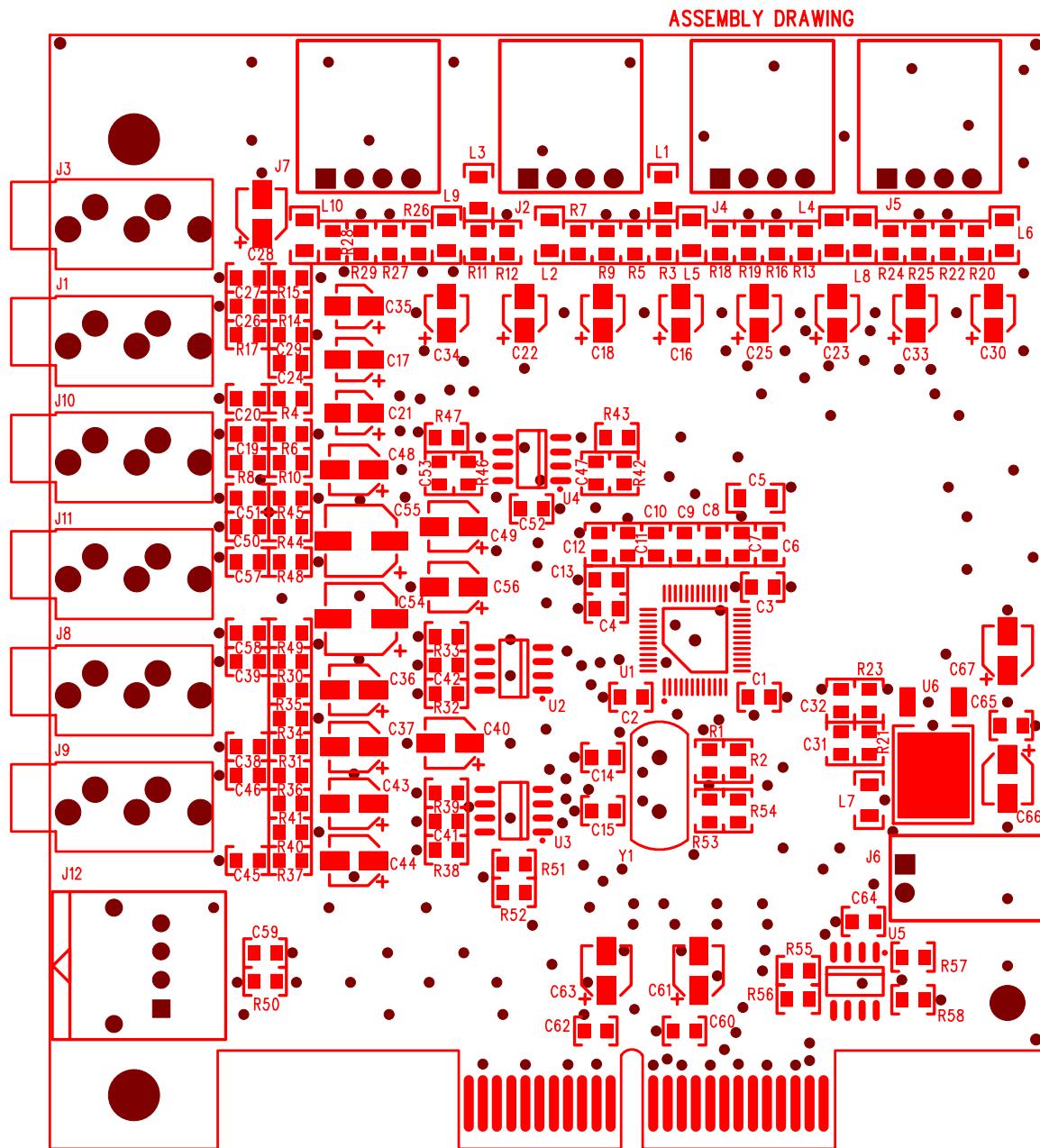


Figure 8. PCB Layout: Top Assembly Drawing

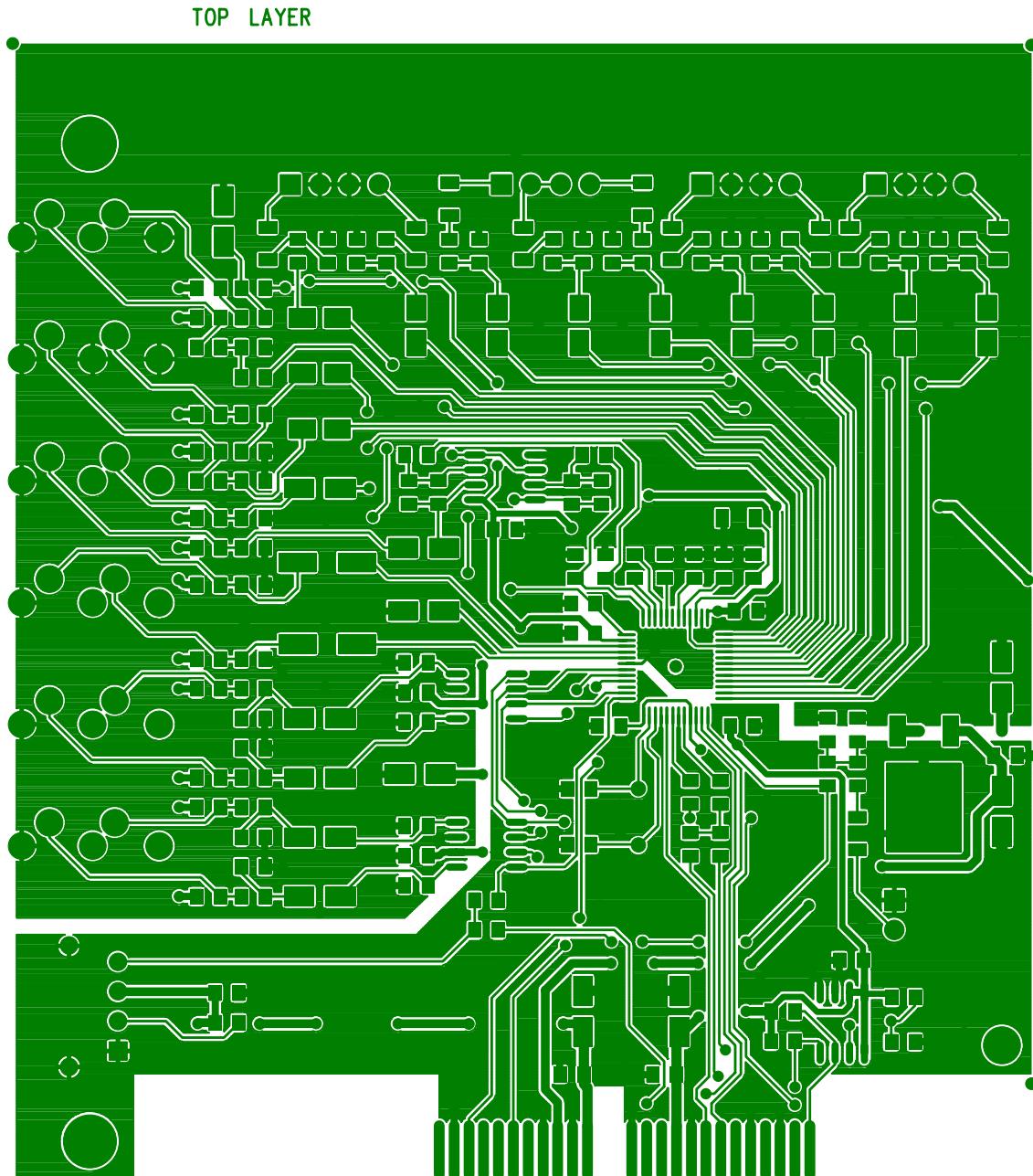


Figure 9. PCB Layout: Top Layer

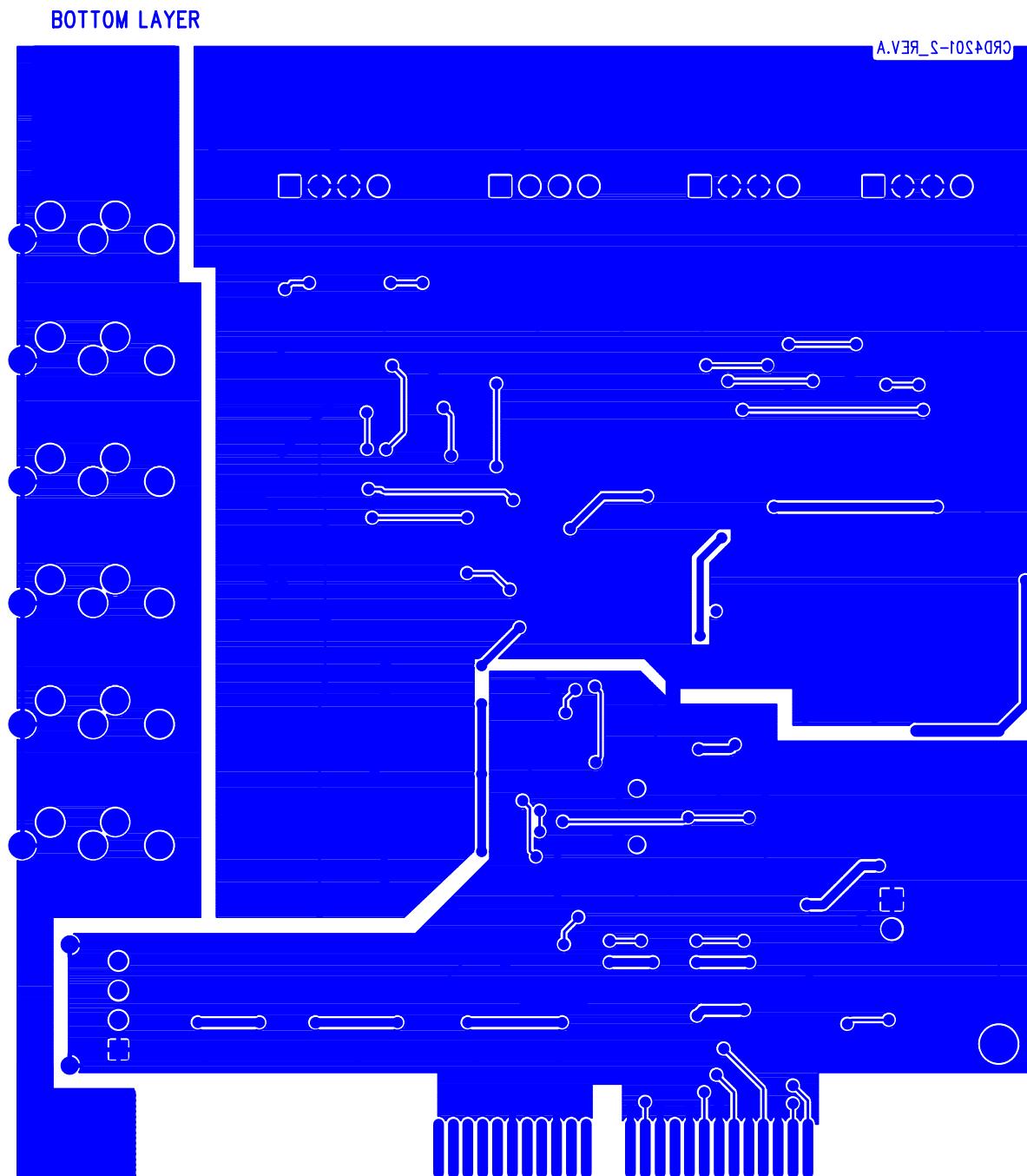
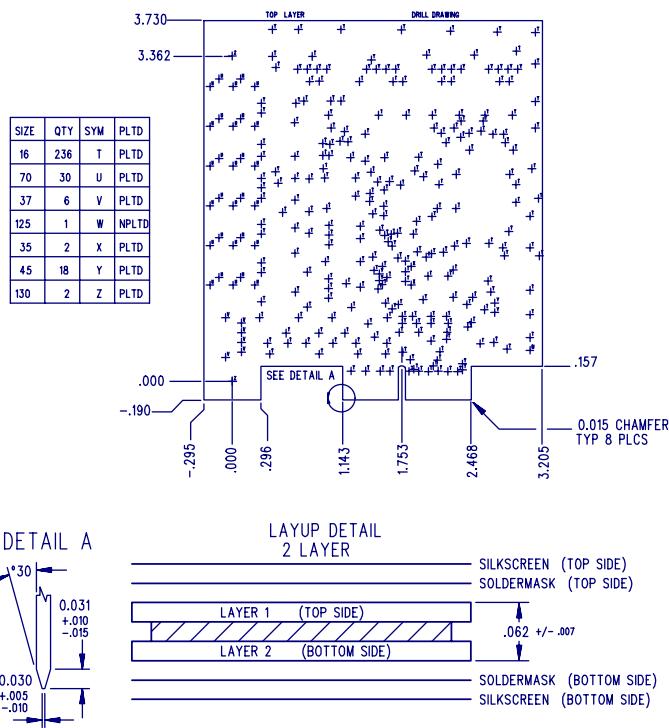


Figure 10. PCB Layout: Bottom Layer



14. SURFACE MOUNT PAD SOLDER PLATING MUST BE FLAT TO A MAXIMUM OF .003" ABOVE BOARD SURFACE.
13. PLATE EDGE CONNECTOR, .00003" MINIMUM GOLD THICKNESS OVER .0002" MINIMUM LOW STRESS NICKEL.
12. .060" MAXIMUM RADIUS ON ALL INSIDE CORNERS.
11. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
10. FABRICATE IN ACCORDANCE WITH IPC-ML-950C, CLASS 2.
9. BOARD SHALL MEET THE REQUIREMENTS OF UL796 WITH A FLAMMABILITY RATING OF 94V-O. VENDOR'S UL LOGO OR DESIGNATION SHALL BE LOCATED ON SOLDER SIDE OF BOARD.
8. REMOVE ALL BURRS AND BREAK SHARP EDGES .015 MAX.
7. SILKSCREEN COMPONENT SIDE USING WHITE EPOXY INK.
6. WARP OR TWIST OF BOARD SHALL NOT EXCEED .010 INCH PER INCH.
5. APPLY SOLDERMASK OVER BARE COPPER. SOLDERMASK TO BE PER IPC-SM-840, TYPE A, CLASS 3, COLOR: TRANSPARENT BLUE. ALL EXPOSED CONDUCTIVE SURFACES TO BE SOLDER COATED.
4. CONDUCTOR WIDTHS AND SPACING SHALL BE WITHIN +/- 20% OF ARTWORK ORIGINALS.
3. ALL HOLES SHALL BE LOCATED WITHIN .003" DIAMETER OF TRUE POSITION. LAYER TO LAYER REGISTRATION SHALL BE WITHIN .003". ALL HOLES SURROUNDED BY LAND SHALL HAVE A MINIMUM ANNUAL RING OF .003.
2. UNLESS OTHERWISE SPECIFIED ALL HOLE DIMENSIONS APPLY AFTER PLATING. ALL PLATED THROUGH HOLES TO HAVE A MINIMUM OF .001" COPPER.
1. MATERIAL: COPPER CLAD PLASTIC SHEET PER MIL-P-1394/4 GPN FINISHED COPPER WEIGHT SHALL BE 1 OZ. COPPER ON INTERNAL SIGNAL LAYERS, 2 OZ. COPPER ON PLANE LAYERS, OUTER LAYERS TO BE 1 OZ. FINISHED. LAMINATE USING PRE-PREG MATERIAL PER MIL-P-1394/12, TYPE PC-GF. OVERALL BOARD THICKNESS TO BE .062 +/- .007

NOTES: UNLESS OTHERWISE SPECIFIED

Figure 11. PCB Layout: Drill Drawing

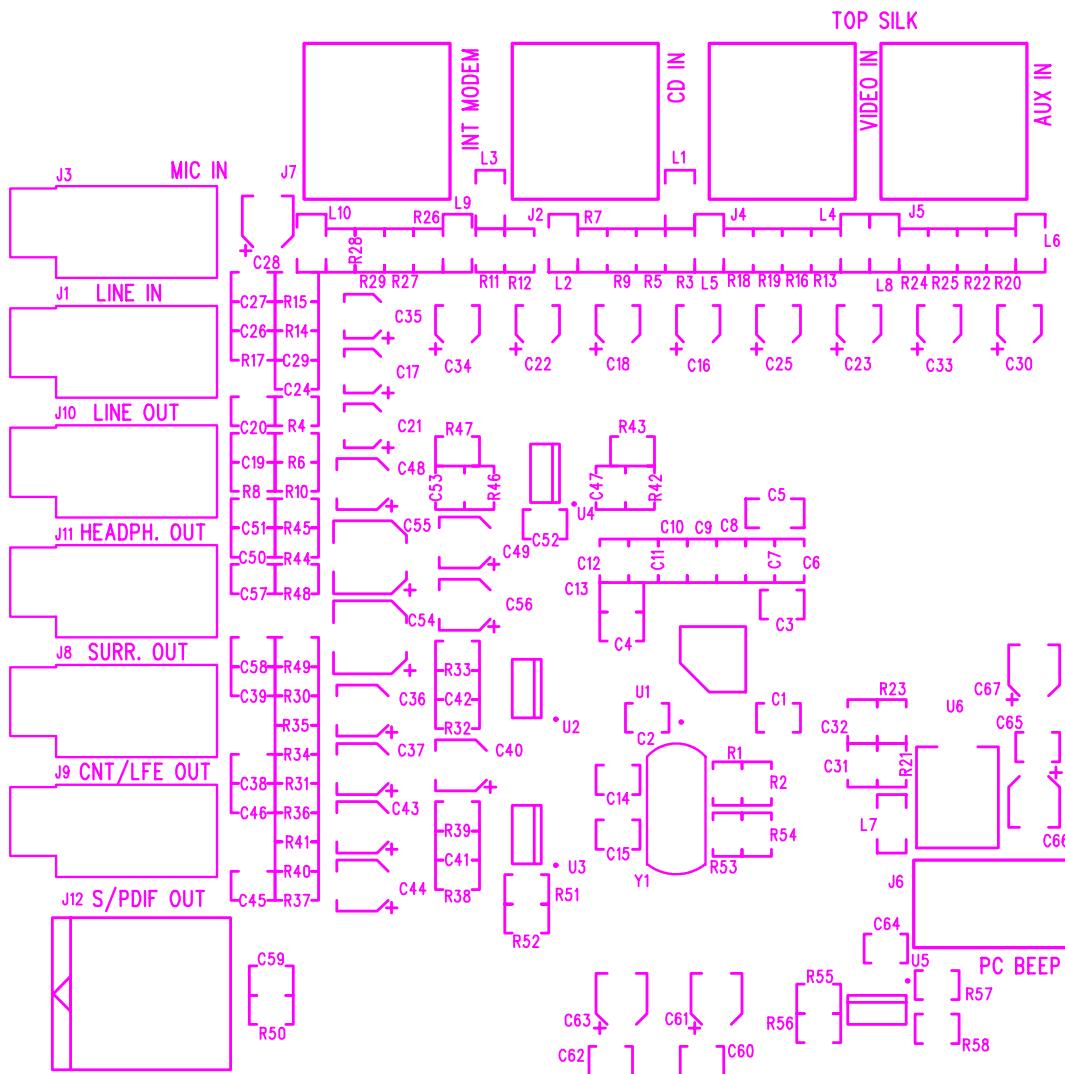


Figure 12. PCB Layout: Top Silkscreen

5. BILL OF MATERIALS

Item	Quantity	Reference	Manufacturer	Part Number	Description
1	14	C1,C2,C3,C4,C6,C31,C41, C42,C52,C59,C60,C62,C64,	KEMET	C0805C104K5RAC	CAP, 0805, X7R, .1uF, 10%, 50V
		C65			
2	1	C5	KEMET	C1206C225M8VAC	CAP, 1206, Y5V, 2.2uF, 20%, 10V
3	6	C7,C8,C10,C11,C12,C13	KEMET	C0805C102K5GAC	CAP, 0805, C0G, 1000pF, 10%, 50V
4	1	C9	KEMET	C0805C103K5RAC	CAP, 0805, X7R, .01uF, 10%, 50V
5	7	C14,C15,C29,C45,C46,C57,	NO POP	NO POP	NO POP
		C58			
6	10	C16,C17,C21,C22,C23,C25, C30,C33,C34,C35	PANASONIC	ECE-V1VVS2R2SR	CAP, SMT A, ELEC, 2.2uF, 20%, 35V
		C18	PANASONIC	ECE-V1ES4R7SR	CAP, SMT A, ELEC, 4.7uF, 20%, 25V
8	6	C19,C20,C26,C27,C50,C51	KEMET	C0805C101J5GAC	CAP, 0805, C0G, 100pF, 5%, 50V
9	1	C24	KEMET	C0805C105M8VAC	CAP, 0805, Y5V, 1uF, 20%, 10V
10	10	C28,C36,C37,C40,C48,C49,	PANASONIC	ECE-V1CA100R	CAP, SMT B, ELEC, 10uF, 20%, 16V
		C61,C63,C66,C67			
11	3	C32,C38,C39	KEMET	C0805C272K5RAC	CAP, 0805, X7R, 2700pF, 10%, 50V
12	3	C43,C44,C56	NO POP	NO POP	NO POP
13	2	C53,C47	KEMET	C0805C220K5GAC	CAP, 0805, C0G, 22pF, 10%, 50V
14	2	C54,C55	NO POP	NO POP	NO POP
15	1	J1	LZR ELECTRON- ICS	SJ372	CONN, 1/8" DOUBLE SW. STEREO PHONE JACK
16	4	J2,J4,J5,J7	MOLEX	70553-0003	HDR 4X1, 0.025" PIN, 0.1" CTR, 15u" AU

17	1	J3	LZR ELECTRON-ICS	SJ374	CONN, 1/8" SINGLE SW. STEREO PHONE JACK
18	1	J6	NO POP	NO POP	NO POP
19	2	J8,J10	LZR ELECTRON-ICS	SJ373	CONN, 1/8" NON-SW. STEREO PHONE JACK
20	2	J9,J11	NO POP	NO POP	NO POP
21	1	J12	TOSHIBA	TOTX173	CONN, OPTICAL TOSLINK TRANSMITTER
22	9	L1,L2,L3,L4,L5,L6,L8,L9, L10	TDK	HF50ACB321611-T	IND, FBEAD, 1206, 31 @ 100MHz, 25%
23	1	L7	TDK	HF50ACB321611-T	NO POP
24	1	P1	NONE	EDGE CONNECTOR	ACR BUS CONNECTOR
25	4	R1,R28,R51,R58	PHILIPS	9C08052A0R00J	RES, SO, 0805, 0, 5%, 1/10W, METAL FILM
26	2	R2,R53	PHILIPS	9C08052A47R0J	RES, SO, 0805, 47, 5%, 1/10W, METAL FILM
27	4	R3,R7,R11,R17	PHILIPS	9C08052A1000J	RES, SO, 0805, 100, 5%, 1/10W, METAL FILM
28	14	R4,R6,R8,R10,R13,R16,R18, R19,R20,R22,R24,R25,R26, R27	PHILIPS	9C08052A6801F	RES, SO, 0805, 6.8K, 1%, 1/10W, METAL FILM
29	7	R5,R9,R12,R21,R29,R34, R35	PHILIPS	9C08052A4702J	RES, SO, 0805, 47K, 5%, 1/10W, METAL FILM
30	1	R14	PHILIPS	9C08052A2201J	RES, SO, 0805, 2.2K, 5%, 1/10W, METAL FILM
31	1	R15	PHILIPS	9C08052A1501J	RES, SO, 0805, 1.5K, 5%, 1/10W, METAL FILM
32	3	R23,R55,R56	PHILIPS	9C08052A4701J	RES, SO, 0805, 4.7K, 5%, 1/10W, METAL FILM
33	2	R30,R31	PHILIPS	9C08052A5600J	RES, SO, 0805, 560, 5%, 1/10W, METAL FILM
34	2	R33,R32	PHILIPS	9C08052A2703J	RES, SO, 0805, 270K, 5%, 1/10W, METAL FILM
35	10	R36,R37,R38,R39,R40,R41, R48,R49,R52,R57	NO POP	NO POP	NO POP

36	2	R42,R46	PHILIPS	9C08052A3302F	RES, SO, 0805, 33K, 1%, 1/10W, METAL FILM
37	2	R43,R47	PHILIPS	9C08052A2702F	RES, SO, 0805, 27K, 1%, 1/10W, METAL FILM
38	2	R45,R44	PHILIPS	9C08052A2203J	RES, SO, 0805, 220K, 5%, 1/10W, METAL FILM
39	1	R50	PHILIPS	9C08052A8201J	RES, SO, 0805, 8.2K, 5%, 1/10W, METAL FILM
40	1	R54	NO POP	NO POP	NO POP
41	1	U1	CIRRUS LOGIC	CS4201-JQ	IC, TQFP, AC 97 2.1 SERIAL CODEC W/ HP AMP + SRC
42	1	U2	CIRRUS LOGIC	CS4334-KS	IC, SO, SOIC8, DAC, STEREO
43	1	U3	NO POP	NO POP	NO POP
44	1	U4	MOTOROLA	MC34072D	IC, SO, SOIC8, 34072, SINGLE SUPPLY DUAL OP AMP
45	1	U5	Microchip	24LC09-I/SN	IC, SO, SOIC8, SERIAL EEPROM, 4 x 256 x 8
46	1	U6	MOTOROLA	MC78M05CDT	IC, SO, +5V REGULATOR, DPAK, 4%, 500mA
47	1	Y1	NO POP	NO POP	NO POP

SMART
Analog™